1. Name of conveying party(ies):
KOO, Kyeong-mo
KU, Ja-hum
PARK, Hye-jeong

Additional names(s) of conveying party(ies) □ Yes ☒ No

3. Nature of conveyance:
☒ Assignment
☐ Merger
☐ Security Agreement
☐ Change of Name
☐ Other

Execution Date: FEBRUARY 13, 17, 16, 2004

4. Application number(s) or patent numbers(s):
If this document is being filed together with a new application, the execution date of the application is:

Patent Application No. Filing date
10/686,768 10/17/2003

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: ADAM C. VOLENTINE
Registration No. 33289
Address: VOLENTINE FRANCOS, PLLC
12200 SUNRISE VALLEY DRIVE, SUITE 150

City: RESTON State/Prov.: VA
Country: U.S.A. ZIP: 20191

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41):$ 40.00
☒ Enclosed - Any excess or insufficiency should be credited or debited to deposit account
☐ Authorized to be charged to deposit account

8. Deposit account number:
50-0238

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To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

ADAM C. VOLENTINE
Name of Person Signing

MARCH 12, 2004
Date

Total number of pages including cover sheet, attachments, and
Mail documents to be recorded with required cover sheet information to:
Mail Stop Assignment Recordation Services
Director of the United States Patent and Trademark Office
P.O. Box 1450, Alexandria, VA 22313-1450

PATENT
REEL: 015077 FRAME: 0771
ASSIGNMENT

In consideration of the sum of One Dollar ($1.00) and other good and valuable consideration paid to each of the undersigned

Insert
Name(s) of Inventor(s)

Kyeong-mo KOO

In-hum KHI

Hyeg-jeong PARK

Insert
Name(s) of Assignee(s) & Address(es)

Samsung Electronics Co., Ltd.
of 416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea

Title of Invention

(hereinafter designated as the Assignee) the entire right, title and interest for the United States as defined in 35 USC 100, in the invention known as Method of Forming Cobalt Silicide Film and Method of Manufacturing Semiconductor Device Having Cobalt Silicide Film

Date of Signing of Application

for which an application for patent in the United States of America has been executed by the undersigned on

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuing, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.
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I further declare that all statements made herein of my own knowledge are true, and that all statements on information and believe are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

1st Inventor  
Kyeongmo Koo  
Kyemyo Koo  
Date: 13/02/2004

2nd Inventor  
Ja-hum Ku  
Ja-hum Ku  
Date: 17/02/2004

3rd Inventor  
Hyun Seong Park  
Hyun Seong Park  
Date: 16/02/2004

4th Inventor  
Date: 

5th Inventor  
Date: 

6th Inventor  
Date: 

Applicant Reference No. SS-20288-US  
Attorney Docket No. SEC.1034/CIP

Page 3 of 3